

X2G50SD12P1

HIGH POWER SPT+ TYPE 2-PACK IGBT MODULE



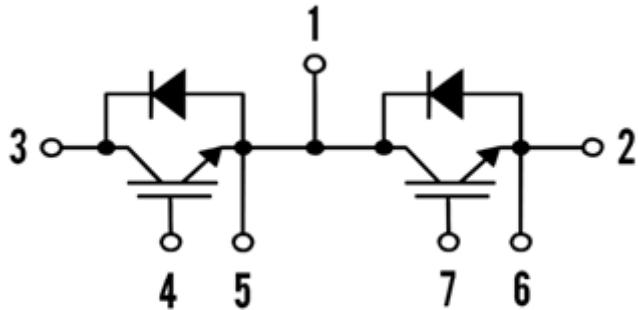
1200V
50A

PACKAGE : M1

FEATURES

- Soft Punch Through (SPT+) Technology
- Fast & soft inverse CAL diodes
- 10us short circuit capability
- Positive $V_{CE(on)}$ temperature coefficient
- Industry standard package

CIRCUIT DIAGRAM



APPLICATIONS

- High power inverter
- Switched mode power supplies (SMPS)
- UPS
- Electrical welding machine

ABSOLUTE MAXIMUM RATINGS

$T_c = 25^\circ\text{C}$, unless otherwise specified

Symbol	Parameter	Conditions	Ratings	Unit
V_{CES}	Collector-emitter voltage	-	1200	V
I_C	DC-collector current	$T_c = 25^\circ\text{C}$	75	A
		$T_c = 80^\circ\text{C}$	57	A
I_{CRM}	Repetitive peak collector current	$T_p=1\text{ms}$ $T_c = 80^\circ\text{C}$	114	A
V_{GES}	Gate-emitter peak voltage	-	± 20	V
I_F	Diode continuous forward current	$T_c = 80^\circ\text{C}$	50	A
I_{FRM}	Diode repetitive peak forward current	-	100	A
$T_{j,max}$	Maximum junction temperature	-	-40 ~ 150	$^\circ\text{C}$
$T_{j,op}$	Operating temperature range	-	-40 ~ 125	$^\circ\text{C}$
T_{stg}	Storage temperature range	-	-40 ~ 125	$^\circ\text{C}$
V_{ISOL}	Insulation test voltage	50/60Hz, $t=1\text{min}$ $I_{ISOL}=1\text{mA}$	2.5	kV
M_S	Mounting screw torque	M6	3.0 ~ 6.0	N.m
M_t	Mounting terminals screw torque	M5	2.5 ~ 5.0	N.m

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■ ELECTRICAL CHARACTERISTICS OF IGBT

 $T_j = 25^\circ\text{C}$ unless otherwise specified

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
$V_{CE(\text{Sat})}$	C-E saturation voltage	-	1.8	-	V	$I_C = 57\text{A}, V_{GE} = 15\text{V}, T_j = 25^\circ\text{C}$
		-	2.0	-	V	$I_C = 57\text{A}, V_{GE} = 15\text{V}, T_j = 125^\circ\text{C}$
$V_{GE(\text{th})}$	G-E threshold voltage	5.0	6.2	7.0	V	$I_C = 2\text{mA}, V_{CE} = V_{GE}$
I_{CES}	Zero gate voltage collector current	-	200	-	μA	$V_{GE} = 0\text{V}, V_{CE} = 1200\text{V}$
I_{GES}	G-E leakage current	-200	-	200	nA	$V_{GE} = \pm 20\text{V}$
R_{Gint}	Internal gate resistance	-	10	-	Ω	-
C_{ies}	Input capacitance	-	4.46	-	nF	$V_{GE} = 0\text{V}, f = 1\text{MHz}, V_{CE} = 25\text{V}, T_j = 25^\circ\text{C}$
C_{oes}	Output capacitance	-	0.5	-		
C_{res}	Reverse transfer capacitance	-	0.3	-		
Q_g	Total gate charge	-	611	-	nC	$V_{GE} = \pm 15\text{V}$
$t_{d(on)}$	Turn-on delay time	-	290	-	ns	$V_{CE} = 600\text{V}, I_C = 57\text{A}, V_{GE} = \pm 15\text{V}, R_G = 18\Omega, T_j = 125^\circ\text{C}$
t_r	Turn-on rise time	-	60	-		
$t_{d(off)}$	Turn-off delay time	-	550	-		
t_f	Turn-off fall time	-	65	-		
E_{ON}	Turn-on Energy loss	-	8.4	-	mJ	
E_{OFF}	Turn-off Energy loss	-	5.8	-		

■ ELECTRICAL CHARACTERISTICS OF FRD

Symbol	Parameter	Min	Typ	Max	Unit	Conditions
V_F	Diode Forward Voltage Drop	-	1.6	-	V	$T_j = 25^\circ\text{C}$
		-	1.6	-		$T_j = 125^\circ\text{C}$
I_{rr}	Peak Reverse Recovery Current	-	30	-	A	$I_F = 57\text{A}$
Q_{rr}	Diode Recovery Charge	-	10	-		$V_{CE} = 600\text{V}$ $V_{GE} = 15\text{V}$ $T_j = 125^\circ\text{C}$

■ THERMAL AND MECHANICAL CHARACTERISTICS

Symbol	Parameter	Min	Typ	Max	Unit	Condition
$R_{th(j-c)}$	Junction-to-Case (IGBT Part, Per 1/2 Module)	-	0.3	-	K/W	
$R_{th(j-c)}$	Junction-to-Case (FRD Part, Per 1/2 Module)	-	1	-	K/W	
$R_{th(c-f)}$	Case-to-Heat Sink (With Thermal Compound)	-	0.05	-	K/W	
Weight	Module		180		g	

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■ PERFORMANCE CURVES (I)

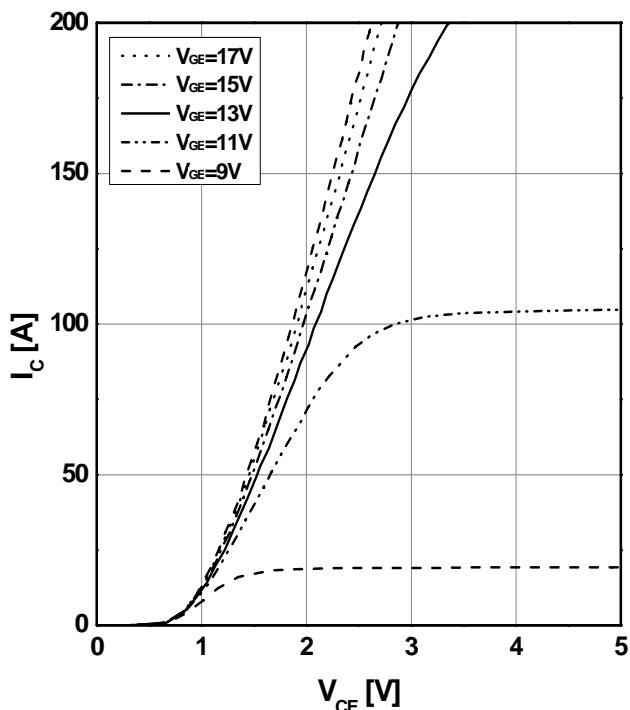


Fig1. Typical Output Characteristics

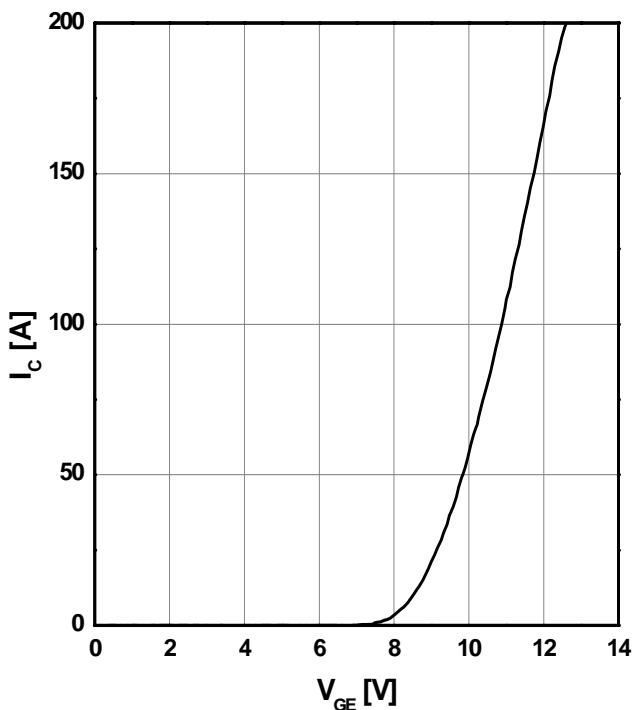


Fig2. Transfer Characteristics

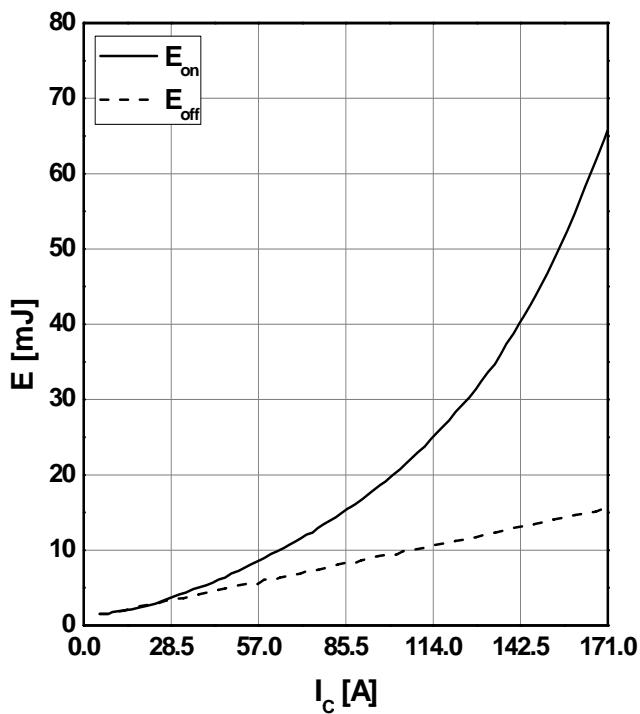


Fig3. Energy Loss vs. I_c

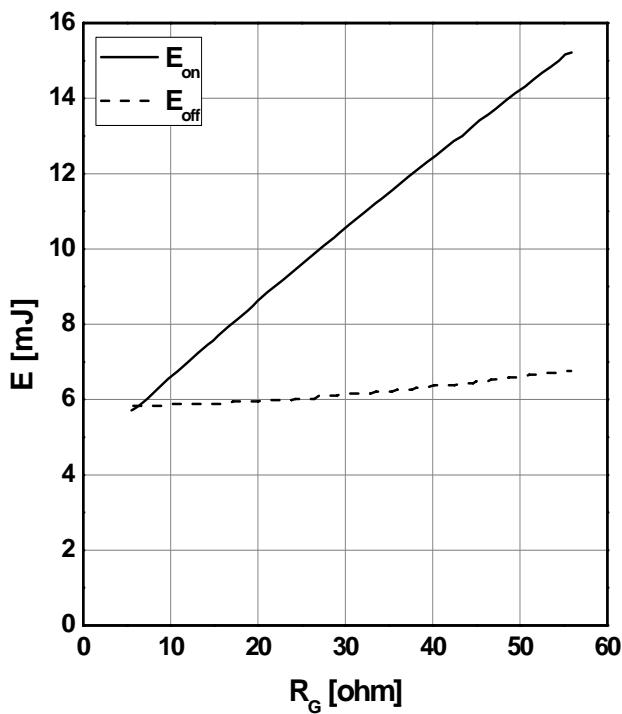


Fig4. Energy Loss vs. R_G

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■ PERFORMANCE CURVES (II)

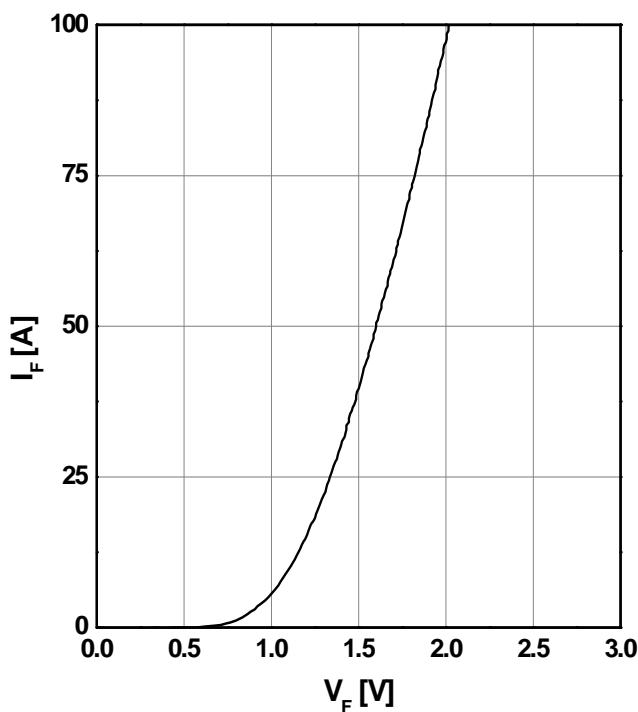


Fig5. DIODE Forward Characteristic

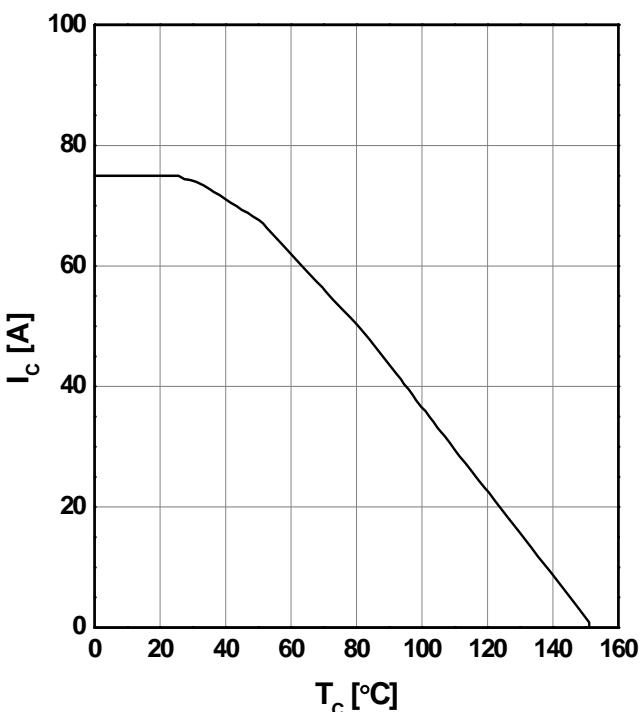


Fig6. Reverse Bios SOA ($T_{vj} = 125^\circ\text{C}$)

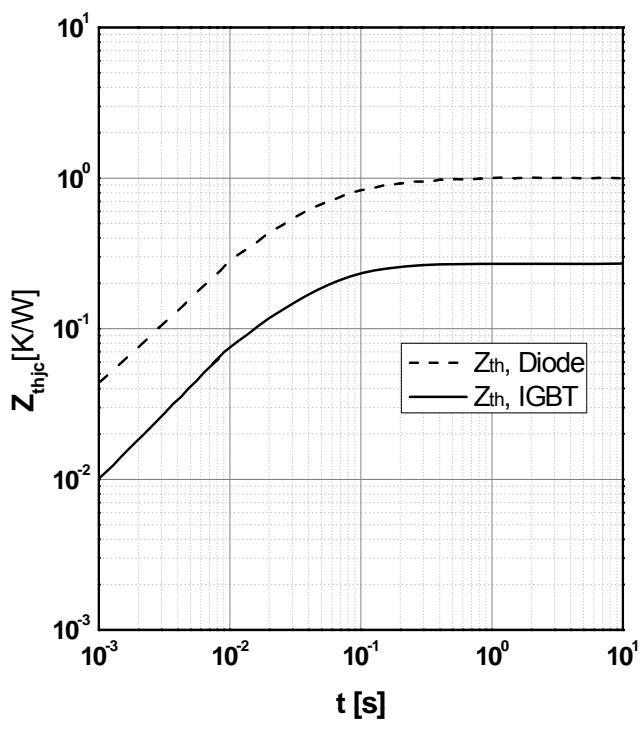


Fig7. Transient Thermal

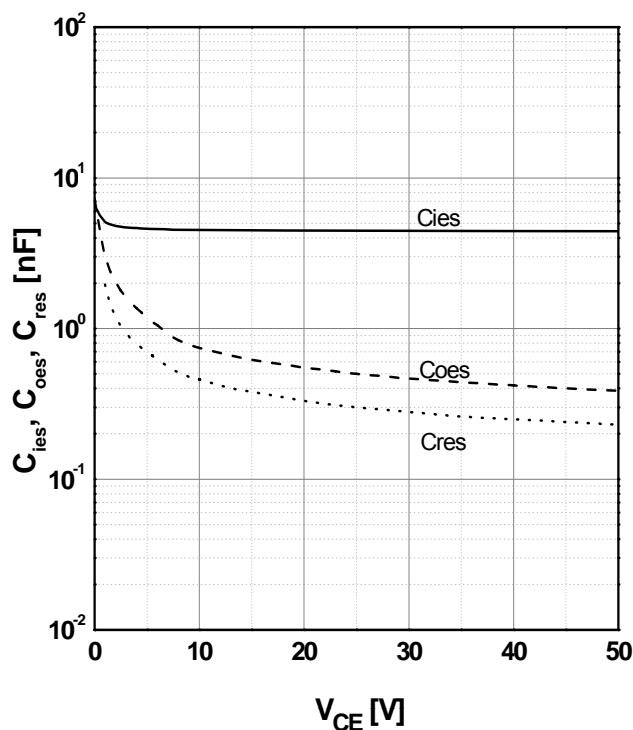
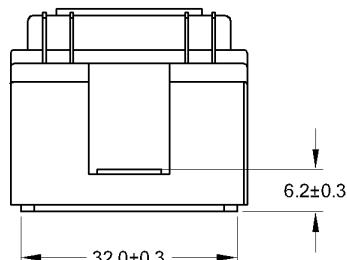
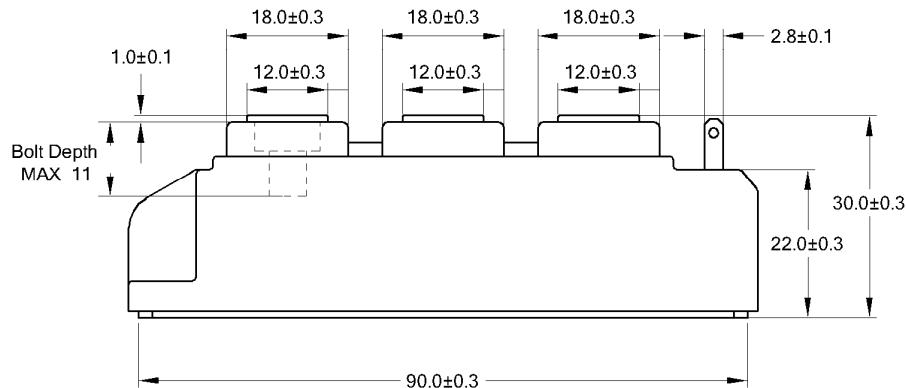
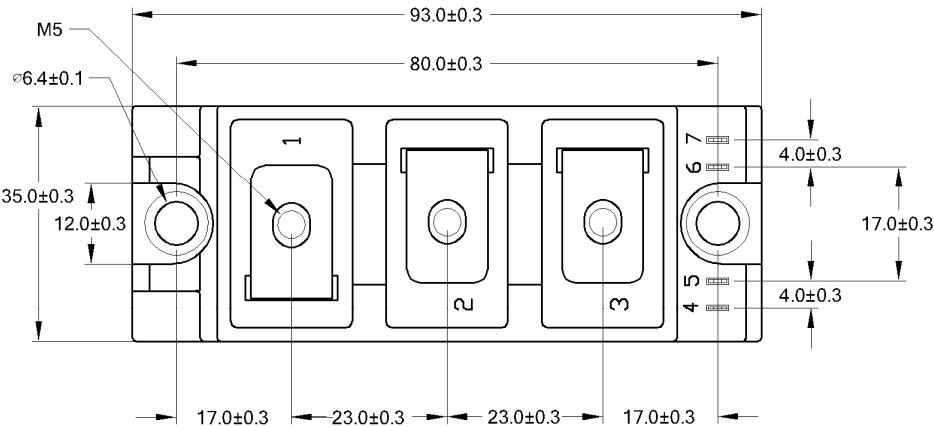


Fig8. Typ. Capacitance

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■ PACKAGE OUTLINES



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